

**QSFP28 Series** 

**Optical Communication System** 



### EQ2Bxx10X-3LCD30

#### 100Gb/s QSFP28 BIDI ER1 Lite Single Lambda Optical Transceiver

- Hot-pluggable QSFP28 form factor
- Support Ethernet CAUI-4
- Support OTU4
- High Sensitivity APD Receiver
- > Operation case temperature C/E/I-Temp
- Single 3.3V power supply
- > Aligned with IEEE 802.3bs and 100G Lambda MSA
- Simplex LC receptacles
- I2C management interface
- RoHS-6 compliant
- 4X28G serial Interface(CEI-28G-VSR)



## Applications

- Transmission over 30km
- Ethernet / OTN OTU4

## **General Description**

The 100G ER1 BIDI Optical Transceiver module is a optical transceiver module designed for single channel O-band over 30km optical transmissions. The module converts 4x25Gb/s(4x28Gb/s) NRZ electrical input data to single channel optical signals for 100Gb/s optical transmission, Reversely, on the receiver side, the module optically converts a 100Gb/s optical input data to 4x25Gb/s (4x28Gb/s) NRZ electrical output data.

The optical interface of the module is a simplex LC and is compliant to the QSFP28 MSA, 100G Lambda MSA. Also it support Dual Rate for 112GBASE-OTU4, It provides an excellent solution for 100G data transmission up to 30km single mode fiber.

### **Functional Description**

QSFP28 Electrical interface: All signal interfaces are compliant with the MSA specifications. The speed DATA interface is differential AC-coupled internally and can directly connected high be to a 3.3V SERDES IC. Hardware control and status reporting pins include 2-wire serial interface а and SDA) and five 3.3V LVTTL hardware signals (ModSelL, ResetL, LPMode, (SCL ModPrsL, and IntL). 2-wire interface pins are 3.3V LVCOMS compatible. Hosts shall use pull-up resistor connected to Vcc\_host on The each of the 2-wire interface SCL, SDA, and all low speed status outputs.

ModSelL: The ModSelL is an input pin. When held low by the host, the module responds to communication commands. The ModSelL allows the use of multiple modules on a single 2-wire 2-wire serial is "High", the module shall not respond to or acknowledge any 2-wire interface bus. When the ModSelL interface communication from the host. ModSelL signal input node shall be biased to the "High" state in the module.

In order to avoid conflicts, the host system shal not attempt 2-wire interface communications within the ModSelL de-assert time after any modules are deselected.Similarly, the host shall wait at least for the period of the ModSelL assert time before communicating with the newly selected module. The assertion and de-asserting periods of different modules may overlap as long as the above timing requirements are met.

ResetL: The ResetL pin shall be pulled to Vcc in the module. A low level on the ResetL pin for longer than the minimum pulse length (t\_Reset\_init) initiates a complete module reset, returning all user module settings to their default state. Module Reset Assert Time (t\_init) starts on the rising edge after the low level on the ResetL pin is released. During the execution of a reset (t\_init) the host shall disregard all status bits until the module indicates a completion of the reset interrupt. The module indicates this by asserting "low" an IntL signal with the Data\_Not\_Ready bit negated. Note that on power up (including hot insertion) the module should post this completion of reset interrupt without requiring a reset.

LPMode: The LPMode pin shall be pulled up to Vcc in the module. The pin is a hardware control used to put modules into a low power mode when high. By using the LPMode pin and a combination of the Power\_override, and Power\_set software control bits (Address A0h, byte 93 bits 0,1), the host controls how much power a module can dissipate. The allowed QSFP28 power consumption is shown in below truth table.

LPMode	Power_	Power_		
PIN	ovorrido bit	oot hit	Power Allowed	
State	override bit	set bit		
1	0	х	1.5W	
0	0	Х	4W	

2

Х	1	1	1.5W
Х	1	0	4W

3

ModPrsL: ModPrsL is pulled up to Vcc\_Host on the host board and grounded in the module. The ModPrsL is asserted "Low" when inserted and deasserted "High" when the module is physically absent from the host connector.

IntL: IntL is an output pin. When IntL is "Low", it indicates a possible module operational fault or a status critical to the host system. The host identifies the source of the interrupt using the 2wire serial interface. The IntL pin is an open collector output and shall be pulled to host supply voltage on the host board. The INTL pin is deasserted "High" after completion of reset, when byte 2 bit 0 (Data Not Ready) is read with a value of '0' and the flag field is read(see SFF-8636).

## Schematic Diagram

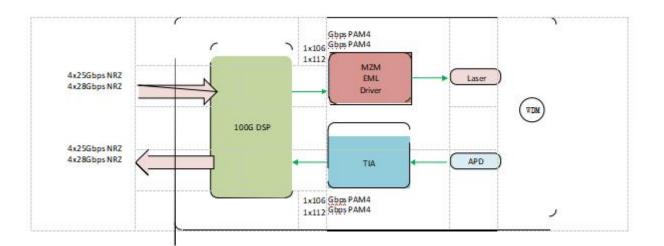
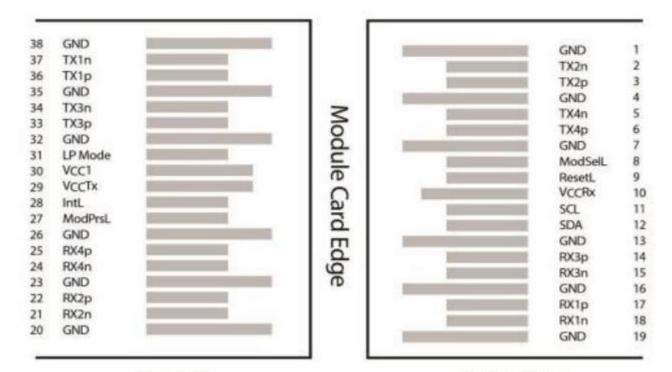


Figure 1. Block Diagram

## **Moudle Connector Pad Layout**



Top Side Viewed From Top

## Bottom Side Viewed From Bottom



### **Module Connector Pad Definition**

PIN	Logic	Symbol	Name/Description	Notes
1	GND	GND	Ground	1
2	CML	Tx2n	Transmitter Inverted Data Input	2
3	CML	Tx2p	Transmitter Non-Inverted Data Input	3
4	GND	GND	Ground	4
5	CML	Tx4n	Transmitter Inverted Data Input	5
6	CML	Tx4p	Transmitter Non-Inverted Data Input	6
7	GND	GND	Ground	7
8	LVTTL	ModSelL	Module Select	8
9	LVTTL	ResetL	Module Reset	9
10	VCC	VCC_Rx	+3.3V Receiver Power Supply	10

11	LVCMOS	SCL	2-wire Serial Interface Clock	11
12	LVCMOS	SDA	2-wire Serial Interface Data	12
13	GND	GND	Ground	13
14	CML	Rx3p	Receiver Non-Inverted Data Output	14
15	CML	Rx3n	Receiver Inverted Data Output	15
16	GND	GND	Ground	16
17	CML	Rx1p	Receiver Non-Inverted Data Output	17
18	CML	Rx1n	Receiver Inverted Data Output	18
19	GND	GND	Ground	19
20	GND	GND	Ground	20
21	CML	Rx2n	Receiver Inverted Data Output	21
22	CML	Rx2p	Receiver Non-Inverted Data Output	22
23	GND	GND	Ground	23
24	CML	Rx4n	Receiver Inverted Data Output	24
25	CML	Rx4p	Receiver Non-Inverted Data Output	25
26	GND	GND	Ground	26
27	LVTTL	ModPrsL	Module Present, grounded inside the module	27
28	LVTTL	IntL	Interrupt	28
29	VCC	VCC_Tx	+3.3V Transmitter Power Supply	29
30	VCC	VCC1	+3.3V Power Supply	30
31	LVTTL	LPMode	Low Power Mode, active high	31
32	GND	GND	Ground	32
33	CML	Tx3p	Transmitter Non-Inverted Data Input	33
34	CML	Tx3n	Transmitter Inverted Data Input	34
35	GND	GND	Ground	35
36	CML	Tx1p	Transmitter Non-Inverted Data Input	36
37	CML	Tx1n	Transmitter Inverted Data Input	37
38	GND	GND	Ground	38

## Absolute Maximum Ratings

Parameter	Symbol	Min	Мах	Units	Notes
Maximum Supply Voltage	VCC	0	3.6	V	
Storage Temperature	TS	-40	85	٥C	
Relative Humidity	RH	0	85	%	
(non-condensation)					
Damage Threshold	THd	-2.4		dBm	

## **Recommended Operating Conditions**

Parameter	Symbol	Min	Typical	Мах	Units	Notes
Supply Voltage	Vcc	3.135	3.3	3.465	V	
Supply Current	lcc			1.21	А	
Power Consumption				4(C-Temp) 4.5(E/I Temp)	W	
	C-Temp	0		70		
Case Temperature	E-Tem	-5		85	٥C	
	I-Temp	-40		85		
Link Distance	D			30	km	

## **Electrical Characteristics**

The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min	Typical	Мах	Units				
	Transmitter (each Lane)								
Signaling rate	Rate		25.78 (CAUI-4)		Gbps				
	Nale		27.95 (OTU4)		Gups				
Differential Input Impedance	Zd	-	100	-	Ω				
Differential Input Voltage per lane	-	-	-	900	mV				
Input impedance mismatch	-	-	-	10	%				
Input High Voltage	VIH	2	-	Vcc+0.3	V				
Input LOW Voltage	VIL	-0.3	-	0.8	V				
		Receiver (each l	Lane)						
Signaling rate	Rate		25.78 (CAUI-4)		Chro				
Signaling rate	Rale		27.95 (OTU4)		Gbps				
Common mode voltage	Vcm	-350	-	2850	mV				
Common Mode Noise, rms	-	-	-	17.5	mV				
Differential Termination				10	%				
Resistance Mismatch (at 1 MHz) Differential Return Loss (SDD22)	-	-	-	Per CEI- 28G-VSR	dB				

Common Mode to					dB
Differential conversion a					
nd Differential to	-	-	-	Per CEI- 28G-VSR	
Common Mode					
Conversion (SDC22,SCD22)					
Common Mode Return Loss					
(SCC22) - from 250 MHz to 30	-	-	-	-2	-
GHz					
Transition Time: 20/80%	-	9.5	-	-	ps
Vertical Eye Closure	VEC	-	-	6.5	dB
Eye width at 10-		0.57			
15robability	EW15	0.57	-	-	UI
Eye height at 10- 15		220			
probability	EH15	228	-	-	mV

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## **Optical Characteristics**

Parameter	Symbol	Min	Typical	Max	Units		
Transmitter (each Lane)							
		53.12	5 ± 100 ppm(	CAUI-4)			
Data Rate (each Lane)		56.2	5 ± 100 ppm(	OTU4)	GBd		
Modulation Format			PAM4				
	UP-LINK		1304.58+/-1.0				
Wavelength	DOWN-LINK		1309.14+/-1.0		nm		
Side-mode Suppression ratio	SMSR	30			dB		
Average launch power <sup>1</sup>	PAVG	0		5.6	dBm		
Outer Optical Modulation Amplitude (OMAouter) TECQ<1.4dB TECQ>1.4dB	POMA	3.0 1.6+TECQ		6.4	dBm		
Transmitter and Dispersion penalty <sup>2</sup>	TDECQ			3.9	dB		
TECQ	TECQ			3.9	dB		
TDECQ-TECQ  (max)				2.7	dB		
Extinction Ratio		5.0			dB		
Optical Return Loss Tolerance				15	dB		
Transmitter Reflectance <sup>3</sup>	RL			-26	dB		
Average Launch Power OFF Transmitter	Poff			- 15	dBm		
RIN <sub>15.6</sub> OMA	RIN			- 136	dB/Hz		

		Receiver (ea	ch Lane)		
Data Rate (each Lane)	53.125 ± 100 ppm(CAUI-4)		GBd		
Modulation Format		56.2	5 ± 100 ppm(	(OUT4)	
	UP-LINK		1309.14+/-1.0		
Lane Wavelength	DOWN-LINK		1304.58+/-1.0		nm
Damage Threshold <sup>4</sup>		-2.4			dBm
Average receive power <sup>5</sup>		-14.7		-3.4	dBm
Receive Power(OMAouter)				-2.6	dBm
Receiver Reflectance				-26	dB
Receiver sensitivity(OMAouter)				Max(-12.5, TECQ- 13.9)	dBm
Stressed receiver sensitivity (OMAouter), each laned (max) <sup>6</sup>	SRS			-4.1	dBm
Receiver Reflectance				-26	dB
LOS Assert	LOSA	-30		-19.5	dBm
LOS De-assert	LOSD			-16.5	dBm
LOS Hysteresi	LOSH	0.5			dB
	Conditio	ns of Stress Rec	eiver Sensitivity 1	Test	
Stressed eye closure for PAM4 (SECQ), lane under test				3.9	dB

Notes:

1. Average launch power (min) is informative and not the principal indicator of signal strength. A

transmitter with launch power below this value cannot be compliant; however, a value above

this does not ensure compliance.

2. TDECQ test based on 30km fiber.

3. Transmitter Reflectance is defined looking into the transmitter.

4. The receiver shall be able to tolerate, without damage, continuous exposure to a modulated optical input signal having this power level on one lane.

5. Average receive power (min) is informative and not the principal indicator of signal strength.

A received power below this value cannot be compliant; however, a value above this does not ensure compliance.

6.Measured with conformance test signal at TP3 for the BER specified in IEEE Std 802.3cd.

#### **Interacing The Transceiver**

Host can determine the characteristic and status of the transceiver through a 2-wire common management interface. The interface also provides host a mechanism to control the operation of a module. SFF-8636 describes the interface details such as memory map and communication protocol used to transfer information between host and a module.

The common memory map is arranged into a single lower page address space (A0h) of 128 bytes and multiple

upper address pages. This structure permits timely access to addresses in the lower page such as interrupt flags and monitors. Less time critical entries such as serial ID information and threshold settings are available with the page select function.

### Lower Memory Overview

Address	Size	Subject Area	Description
			Module ID from SFF-8024 list, version number, Type and
			status
0–3	4	ID and Status Area	Flat mem indication, CLEI present indicator,
0.0			Maximum TWI speed, Current state of Module, Current
			state of the Interrupt signal
4–7	4	Lane Flag Summary	Flag summary of all lane flags on pages 10h-1Fh
8– 13	6	Module-Level Flags	All flags that are not lane or data path specific
14-25	12	Module-Level Monitors	Monitors that are not lane or data path specific
26-30	5	Module Global Controls	Controls applicable to the module as a whole
31-36	6	Module-Level Flag Masks	Masking bits for the Module-Level flags
37-38	2	CDB Status Area	Status of most recent CDB command
39-40	2	Module Firmware Version	Module Firmware Version.
41-63	23	Reserved Area	Reserved for future standardization
64-82	19	Custom Area	Vendor or module type specific use
			Version Number of Inactive Firmware. Values of 00h
83-84	2	Inactive Firmware Version	indicates module supports only a single image.
			Combinations of host and media interfaces
85- 117	33	Application Advertising	that are supported by module data path(s)
118-125	8	Password Entry and	
110-120	0	Change	
126	1	Bank Select Byte	Bank address of currently visible Page
127	1	Page Select Byte	Page address of currently visible Page

## **Digital Diagnostic Functions**

The following digital diagnostic characteristics are defined over the normal operating conditions unless otherwise specified.

Parameter	Symbol	Min	Мах	Units	Notes
Temperature monitor absolute error	DMI Temp	-3	3	degC	Over operating
	Divil_Temp	-5	5		temperature range
Supply voltage monitor absolute error		-0.1	0.1	V	Over full operating
Supply voltage monitor absolute enor	DMI_VCC	-0.1	0.1		range
Channel RX power monitor	DMI_RX_Ch	-3	3	dB	1

absolute error					
Channel Bias current monitor	DMI_lbias_Ch	- 10%	10%	mA	
Channel TX power monitor absolute error	DMI_TX_Ch	-3	3	dB	1

Notes:

Due to measurement accuracy of different single mode fibers, there could be an additional +/-1 dB fluctuation, or a +/-3 dB total accuracy

## **Mechanical Dimensions**

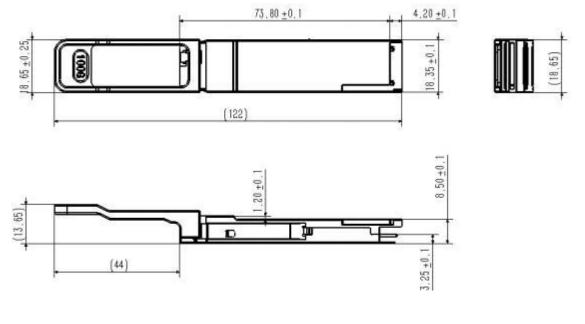


Figure 3. Mechanical Schematic

### ESD

This transceiver is specified as ESD threshold 1kV for high speed data pins and 2kV for all other electrical input pins, tested per MIL-STD-883, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.

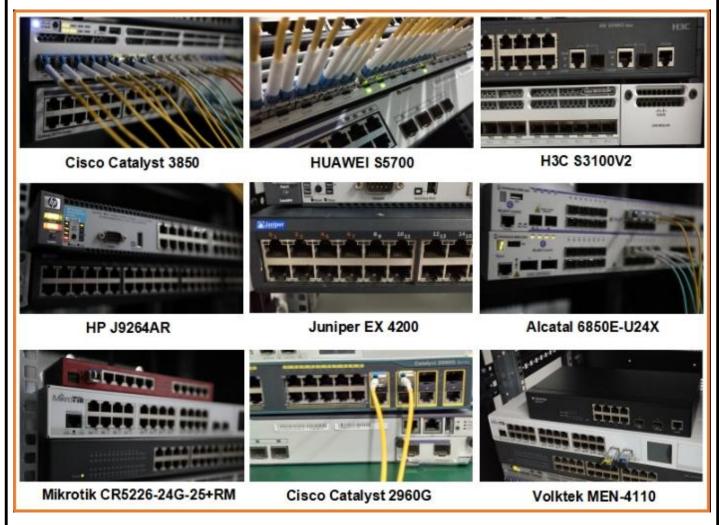
### Laser Safety

This is a Class 1 Laser Product according to EN/IEC 60825-1:2014. This product Complies with 21 CFR 1040.10 and 1040.11 except for conformance with IEC 60825-1 Ed. 3., as described in Laser Notice No. 56, dated May 8, 2019. Caution: Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

### **Compatibility Test**

In order to ensure the product compatibility, our products will be tested on the switch before shipment. Ourmodules can compatible with many mainstream brand switches, such as Cisco, Juniper, Extreme, Brocade, IBM, H3C, HP, Huawei, D-Link, Mikrotik, ZTE, TP-Link...

Our test equipment: VOLKTEK MEN-4110, HP 2530-8G, CRS226-24G-25+RM, Catalyst 2960G Series, Catalyst 3850 XS 10G SFP+, Catalyst 3750-E Series, HUAWEI S5700Series, H3C S3100V2 Series, Juniper-EX4200, etc.



### **Product Production Process**

# **Quality Assurance**

Continuous introduction of new equipment, produced by strict standards, strict quality inspection, to guarantee the high quality standard of each product.

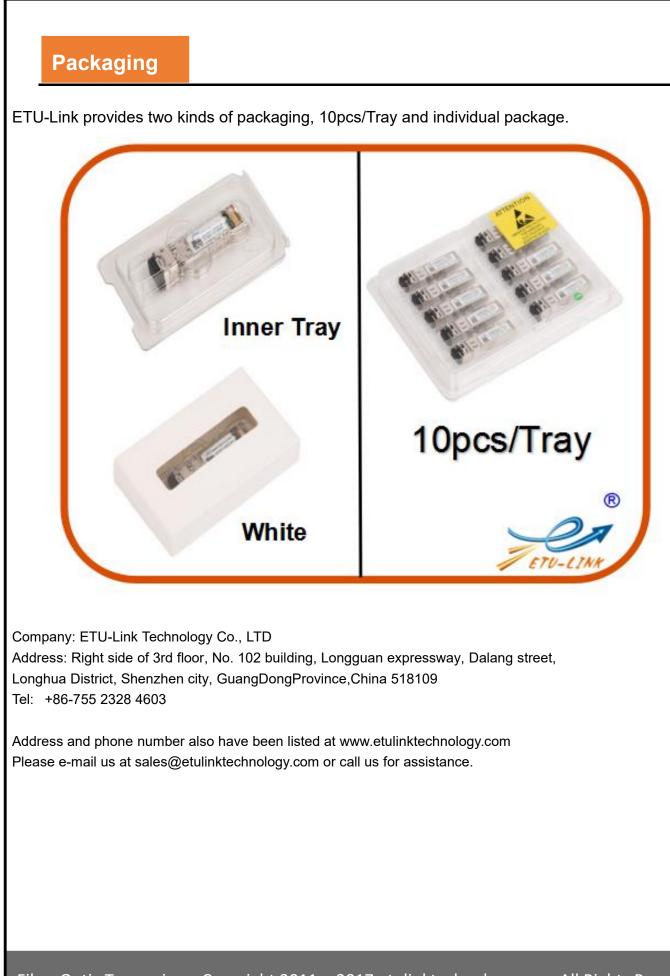


**Product Initial Test** 

Switch Testing

**Product Final Test** 

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